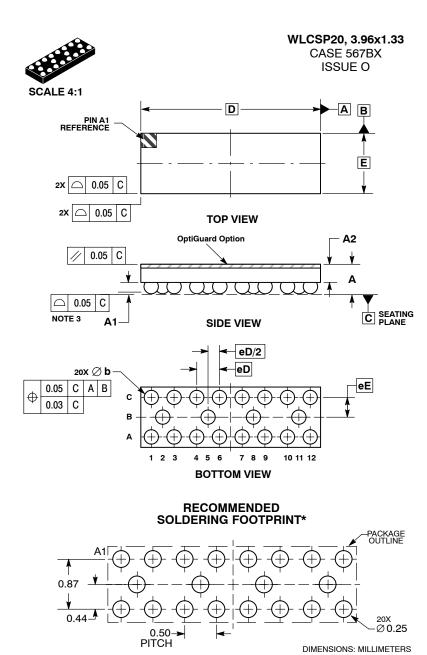
<u>Onsemi</u>



DATE 26 JUL 2010

NOTES: 1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994. 2. CONTROLLING DIMENSION: MILLIMETERS ADDITED ADDITE

 CONTROLLING DIMENSION: MILLIMETERS.
COPLANARITY APPLIES TO SPHERICAL CROWNS OF SOLDER BALLS.

	MILLIMETERS		
DIM	MIN	MAX	
Α	0.56	0.72	
A1	0.21	0.27	
A2	0.40 REF		
b	0.29	0.35	
D	3.96 BSC		
Е	1.33 BSC		
eD	0.50 BSC		
еE	0.435 BSC		

*For additional information on our Pb–Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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DESCRIPTION:	WLCSP20, 3.96X1.33		PAGE 1 OF 1		
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